



74LVT162374

3.3 V 16-bit edge-triggered D-type flip-flop with 30 Ω termination resistors; 3-state

Rev. 6 — 8 July 2024

Product data sheet

1. General description

The 74LVT162374 is a high performance BiCMOS product designed for V_{CC} operation at 3.3 V.

The 74LVT162374 is designed with 30 Ω series resistance in both the HIGH and LOW states of the output. This design reduces line noise in applications such as memory address drivers, clock drivers, and bus receivers/transmitters.

This device is a 16-bit edge-triggered D-type flip-flop featuring non-inverting 3-state outputs. The device can be used as two 8-bit flip-flops or one 16-bit flip-flop. On the positive transition of the clock (CP), the Q outputs of the flip-flop take on the logic levels set up at the D inputs.

2. Features and benefits

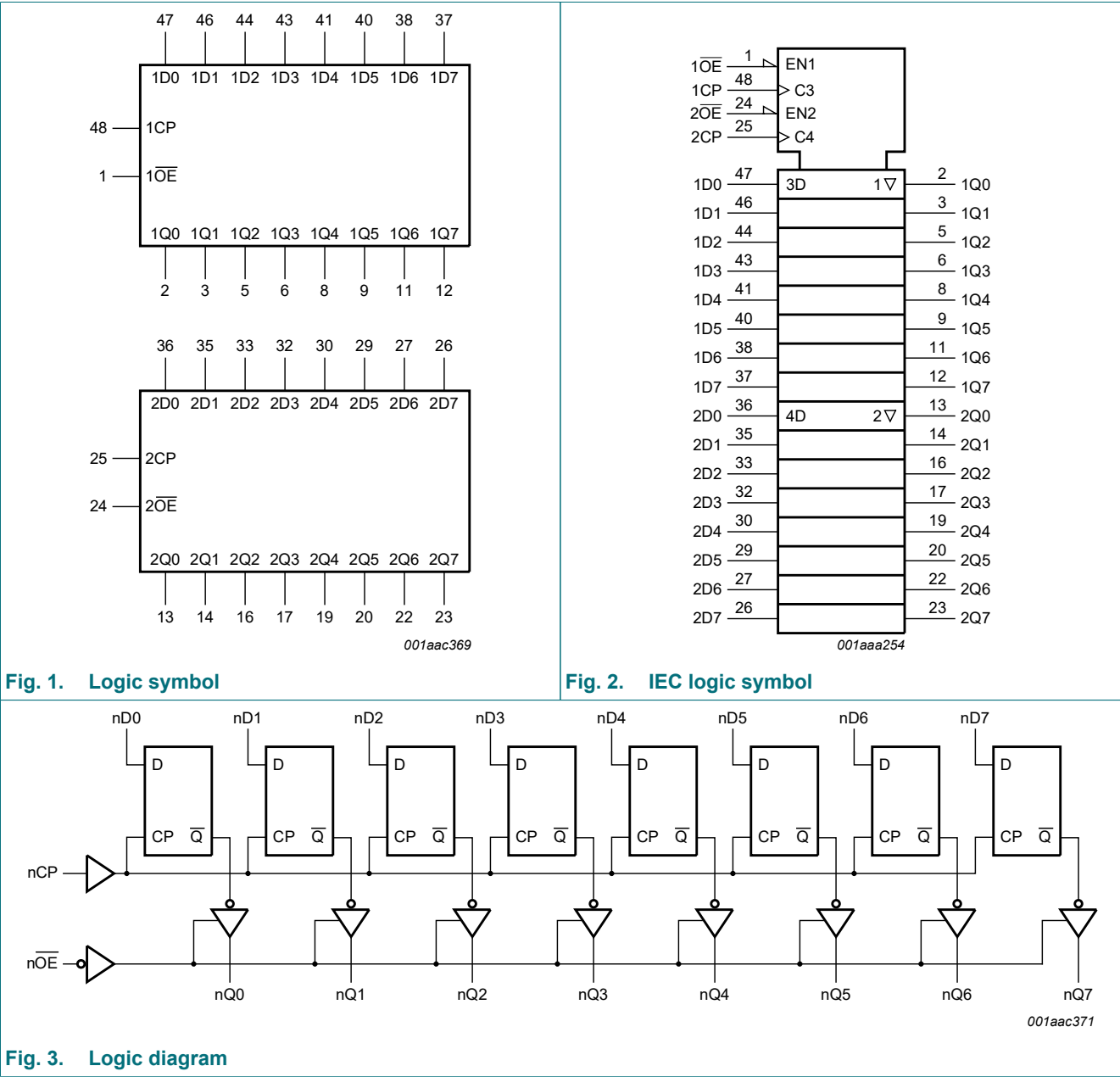
- 16-bit edge-triggered flip-flop
- 3-state buffers
- Output capability: +12 mA and -12 mA
- TTL input and output switching levels
- Input and output interface capability to systems at 5 V supply
- Bus-hold data inputs eliminate the need for external pull-up resistors to hold unused inputs
- Live insertion and extraction permitted
- Outputs include series resistance of 30 Ω making external resistors unnecessary
- Power-up reset
- Power-up 3-state
- No bus current loading when output is tied to 5 V bus
- Latch-up protection:
 - JESD78B Class II exceeds 500 mA
- ESD protection:
 - HBM: ANSI/ESDA/JEDEC JS-001 class 2 exceeds 2000 V
 - CDM: ANSI/ESDA/JEDEC JS-002 class C3 exceeds 1000 V
- Specified from -40 °C to +85 °C

3. Ordering information

Table 1. Ordering information

| Type number | Package | | | |
|--------------------------------|-------------------|---------|---|--------------------------|
| | Temperature range | Name | Description | Version |
| 74LVT162374DGG | -40 °C to +85 °C | TSSOP48 | plastic thin shrink small outline package; 48 leads; body width 6.1 mm | SOT362-1 |

4. Functional diagram



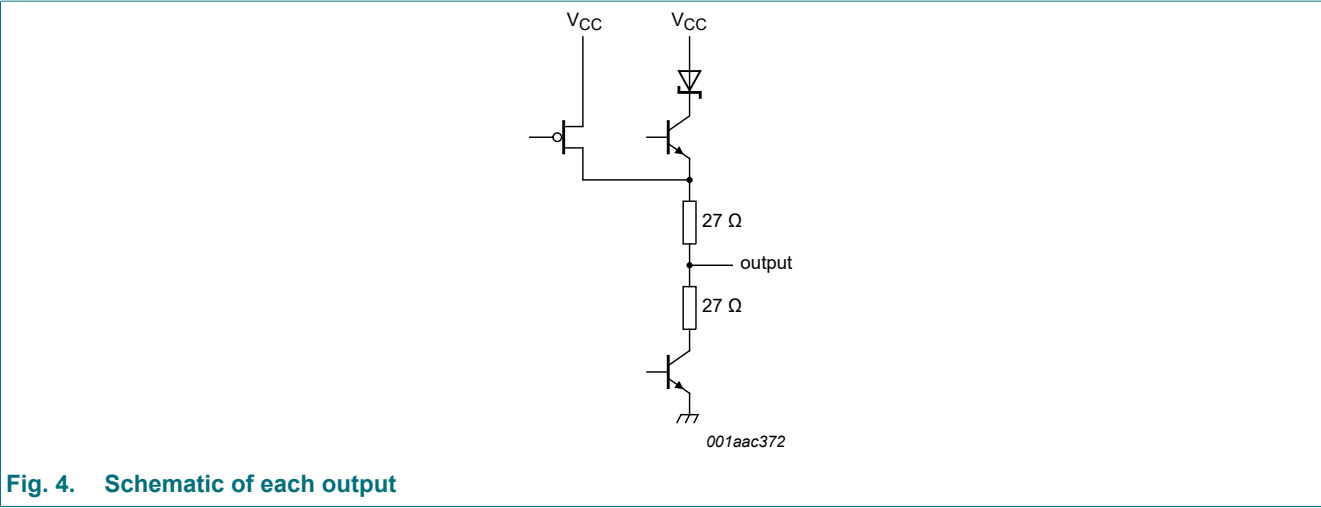
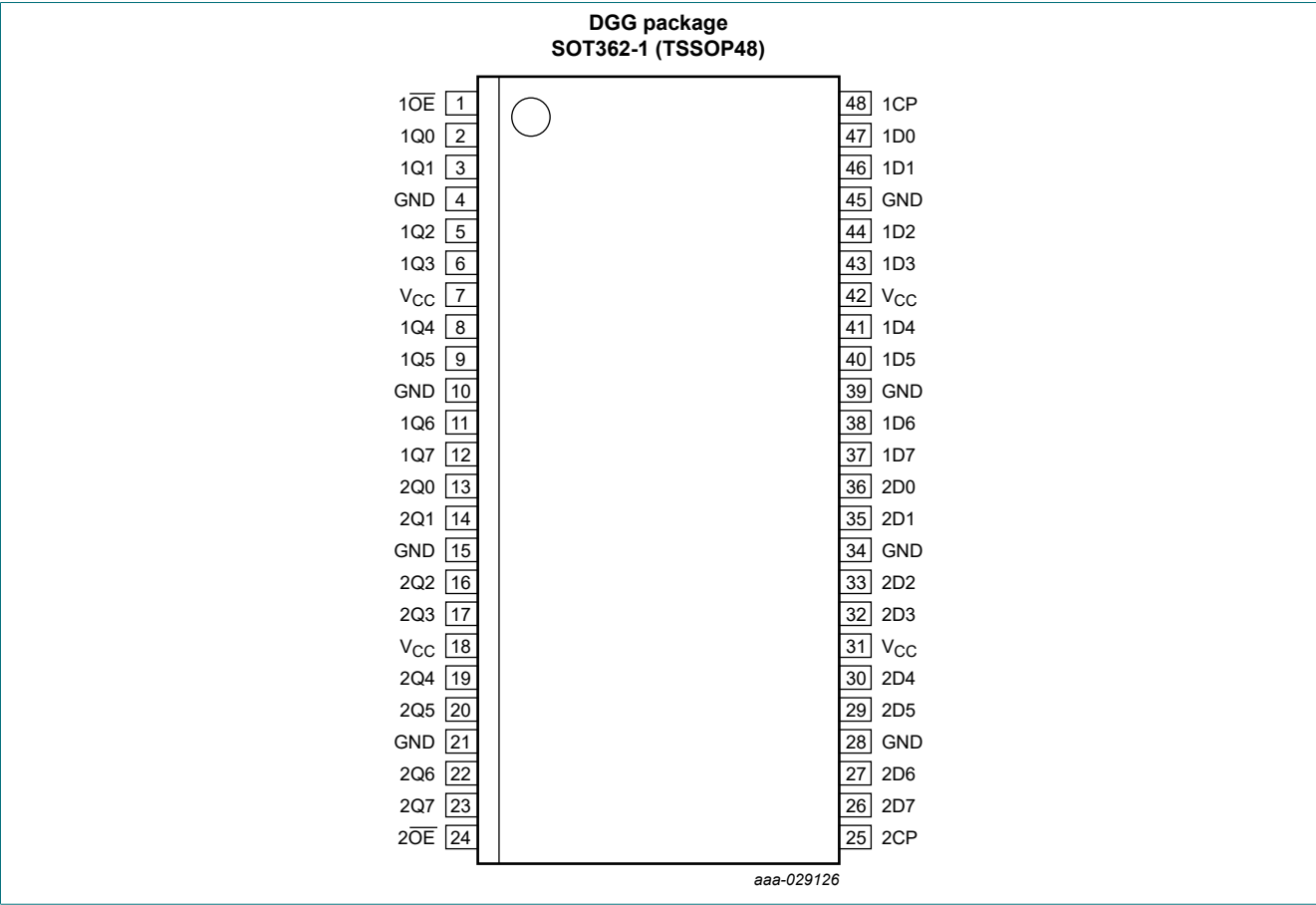


Fig. 4. Schematic of each output

5. Pinning information

5.1. Pinning



5.2. Pin description

Table 2. Pin description

| Symbol | Pin | Description |
|--|--------------------------------|---|
| 1D0, 1D1, 1D2, 1D3, 1D4, 1D5, 1D6, 1D7 | 47, 46, 44, 43, 41, 40, 38, 37 | data inputs |
| 2D0, 2D1, 2D2, 2D3, 2D4, 2D5, 2D6, 2D7 | 36, 35, 33, 32, 30, 29, 27, 26 | data inputs |
| 1Q0, 1Q1, 1Q2, 1Q3, 1Q4, 1Q5, 1Q6, 1Q7 | 2, 3, 5, 6, 8, 9, 11, 12 | data outputs |
| 2Q0, 2Q1, 2Q2, 2Q3, 2Q4, 2Q5, 2Q6, 2Q7 | 13, 14, 16, 17, 19, 20, 22, 23 | data outputs |
| 1OE, 2OE | 1, 24 | output enable inputs (active LOW) |
| 1CP, 2CP | 48, 25 | clock pulse inputs (active rising edge) |
| GND | 4, 10, 15, 21, 28, 34, 39, 45 | ground (0 V) |
| V _{CC} | 7, 18, 31, 42 | supply voltage |

6. Functional description

Table 3. Function table

*H = HIGH voltage level; h = HIGH voltage level one set-up time prior to the LOW-to-HIGH clock transition;
L = LOW voltage level; l = LOW voltage level one set-up time prior to the LOW-to-HIGH clock transition;
↑ = LOW-to-HIGH clock transition; NC = no change;
X = don't care; Z = high-impedance OFF-state.*

| Operating mode | Input | | | Internal flip-flops | Output |
|------------------------|-------|-----|-----|---------------------|--------|
| | nOE | nCP | nDn | | nQn |
| Load and read register | L | ↑ | l | L | L |
| | L | ↑ | h | H | H |
| Hold | L | NC | X | NC | NC |
| Disable outputs | H | NC | X | NC | Z |
| | H | ↑ | nDn | nDn | Z |

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V)

| Symbol | Parameter | Conditions | Min | Max | Unit |
|------------------|-------------------------|---------------------------------------|------|------|------|
| V _{CC} | supply voltage | | -0.5 | +4.6 | V |
| V _I | input voltage | [1] | -0.5 | +7.0 | V |
| V _O | output voltage | output in OFF-state or HIGH-state [1] | -0.5 | +7.0 | V |
| I _{IK} | input clamping current | V _I < 0 V | -50 | - | mA |
| I _{OK} | output clamping current | V _O < 0 V | -50 | - | mA |
| I _O | output current | output in LOW-state | - | 128 | mA |
| | | output in HIGH-state | -64 | - | mA |
| T _{stg} | storage temperature | | -65 | +150 | °C |
| T _j | junction temperature | [2] | | +150 | °C |

[1] The input and output negative voltage ratings may be exceeded if the input and output clamp current ratings are observed.
[2] The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability.

8. Recommended operating conditions

Table 5. Recommended operating conditions

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|------------------|-------------------------------------|-----------------|-----|-----|-----|------|
| V _{CC} | supply voltage | | 2.7 | - | 3.6 | V |
| V _I | input voltage | | 0 | - | 5.5 | V |
| Δt/ΔV | input transition rise and fall rate | outputs enabled | - | - | 10 | ns/V |
| T _{amb} | ambient temperature | | -40 | - | +85 | °C |

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Typ[1] | Max | Unit |
|-----------------------|------------------------------------|---|-----|--------|------|------|
| V _{IK} | input clamping voltage | V _{CC} = 2.7 V; I _{IK} = -18 mA | - | -0.85 | -1.2 | V |
| V _{IH} | HIGH-level input voltage | | 2.0 | - | - | V |
| V _{IL} | LOW-level input voltage | | - | - | 0.8 | V |
| V _{OH} | HIGH-level output voltage | V _{CC} = 3.0 V; I _{OH} = -12 mA | 2.0 | - | - | V |
| V _{OL} | LOW-level output voltage | V _{CC} = 3.0 V; I _{OL} = 12 mA | - | - | 0.8 | V |
| I _{OH} | HIGH-level output current | | - | - | -12 | mA |
| I _{OL} | LOW-level output current | | - | - | 12 | mA |
| V _{OL(pu)} | power-up LOW-level output voltage | V _{CC} = 3.6 V; I _O = 1 mA; V _I = GND or V _{CC} [2] | - | 0.1 | 0.55 | V |
| I _I | input leakage current | all input pins [3] | | | | |
| | | V _{CC} = 0 V or 3.6 V; V _I = 5.5 V | - | 0.4 | 10 | μA |
| | | control pins [3] | | | | |
| | | V _{CC} = 3.6 V; V _I = V _{CC} or GND | - | 0.1 | ±1 | μA |
| | | I/O data pins; V _{CC} = 3.6 V [3] | | | | |
| | | V _I = V _{CC} | - | 0.1 | 1 | μA |
| | | V _I = 0 V | - | -0.4 | -5 | μA |
| I _{OFF} | power-off leakage current | V _{CC} = 0 V; V _I or V _O = 0 V to 4.5 V | - | 0.1 | ±100 | μA |
| I _{BHL} | bus hold LOW current | nDn inputs; V _{CC} = 3 V; V _I = 0.8 V | 75 | 135 | - | μA |
| I _{BHH} | bus hold HIGH current | nDn inputs; V _{CC} = 3 V; V _I = 2.0 V | -75 | -135 | - | μA |
| I _{BHLO} | bus hold LOW overdrive current | nDn inputs; V _{CC} = 3.6 V; V _I = 0 V to 3.6 V [4] | 500 | - | - | μA |
| I _{BHHO} | bus hold HIGH overdrive current | nDn inputs; V _{CC} = 3.6 V; V _I = 0 V to 3.6 V [4] | - | - | -500 | μA |
| I _{CEX} | output high leakage current | output in HIGH-state when V _O > V _{CC} ; V _O = 5.5 V; V _{CC} = 3.0 V | - | 50 | 125 | μA |
| I _{O(pu/pd)} | power-up/power-down output current | V _{CC} ≤ 1.2 V; V _O = 5.0 V to V _{CC} ; V _I = GND or V _{CC} ; nOE = don't care [5] | - | 1 | ±100 | μA |
| I _{OZ} | OFF-state output current | V _{CC} = 3.6 V; V _I = V _{IH} or V _{IL} | | | | |
| | | V _O = 3.0 V | - | 0.5 | 5 | μA |
| | | V _O = 0.5 V | - | 0.5 | -5 | μA |

3.3 V 16-bit edge-triggered D-type flip-flop with 30 Ω termination resistors; 3-state

| Symbol | Parameter | Conditions | Min | Typ[1] | Max | Unit |
|------------------|---------------------------|---|-----|--------|------|------|
| I _{CC} | supply current | V _{CC} = 3.6 V; V _I = GND or V _{CC} ; I _O = 0 A | | | | |
| | | outputs HIGH | - | 0.07 | 0.12 | mA |
| | | outputs LOW | - | 4 | 6 | mA |
| | | outputs disabled [6] | - | 0.07 | 0.12 | mA |
| ΔI _{CC} | additional supply current | per input pin; V _{CC} = 3 V to 3.6 V; one input at V _{CC} - 0.6 V; other inputs at V _{CC} or GND [7] | - | 0.1 | 0.2 | mA |
| C _I | input capacitance | V _I = 0 V or 3.0 V | - | 3 | - | pF |
| C _O | output capacitance | outputs disabled; V _O = 0 V or 3.0 V | - | 9 | - | pF |

- [1] All typical values are measured at V_{CC} = 3.3 V and T_{amb} = 25 °C.
- [2] For valid test results, data must not be loaded into the flip-flops after applying power.
- [3] Unused pins at V_{CC} or GND.
- [4] This is the bus-hold overdrive current required to force the input to the opposite logic state.
- [5] This parameter is valid for any V_{CC} between 0 V and 1.2 V with a transition time of up to 10 ms. From V_{CC} = 1.2 V to V_{CC} = 3.3 V ± 0.3 V a transition time of 100 μs is permitted. This parameter is valid for T_{amb} = 25 °C only.
- [6] I_{CC} is measured with outputs pulled to V_{CC} or GND.
- [7] This is the increase in supply current for each input at the specified voltage level other than V_{CC} or GND.

10. Dynamic characteristics

Table 7. Dynamic characteristics

At recommended operating conditions; Voltages are referenced to GND (ground = 0 V); for test circuit see Fig. 8.

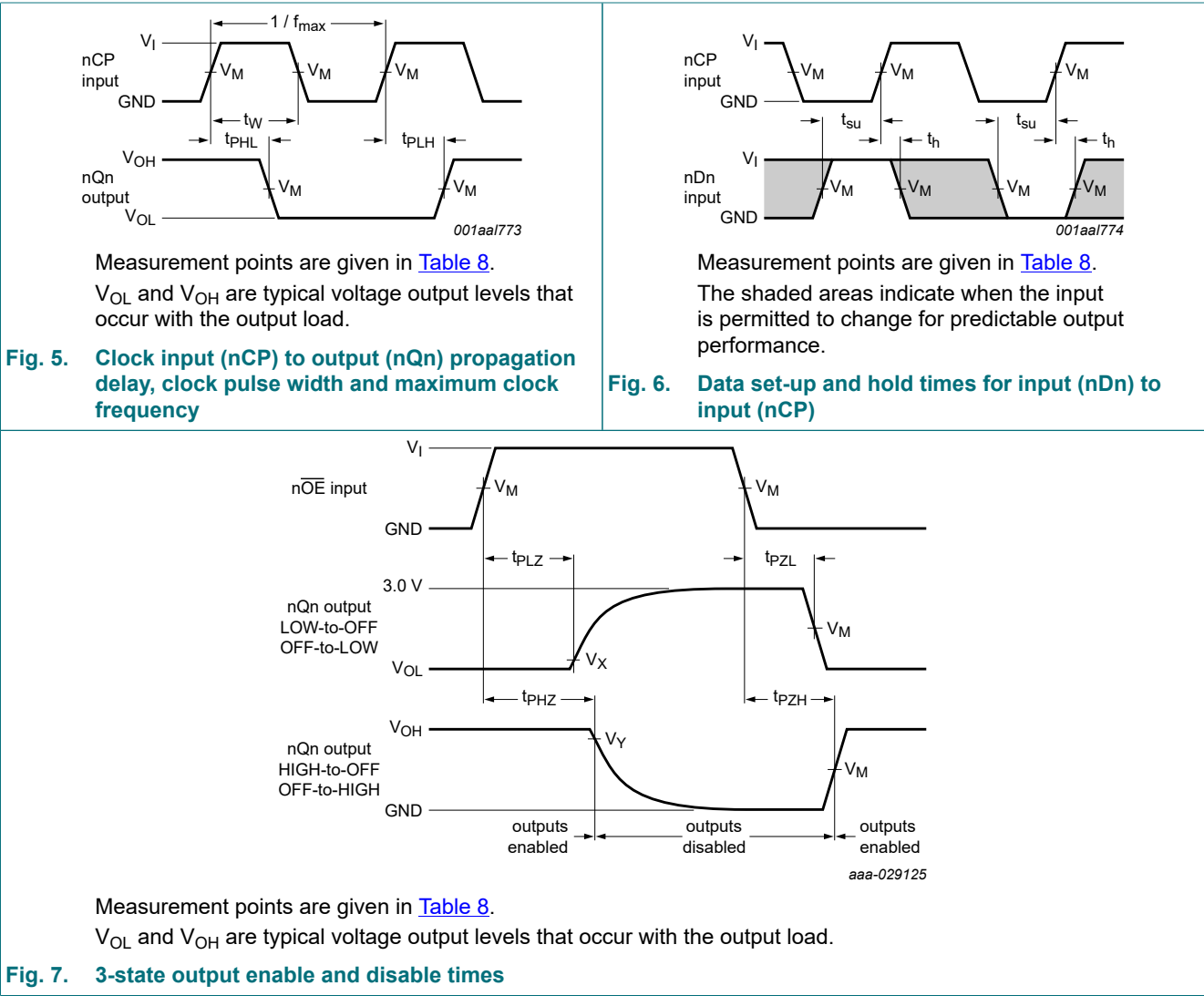
| Symbol | Parameter | Conditions | Min | Typ[1] | Max | Unit |
|------------------|-------------------------------------|---|-----|--------|-----|------|
| f _{max} | maximum frequency | nCP; V _{CC} = 3.0 V to 3.6 V; see Fig. 5 | 150 | - | - | MHz |
| t _{PLH} | LOW to HIGH propagation delay | nCP to nQn; see Fig. 5 | | | | |
| | | V _{CC} = 2.7 V | - | - | 6.2 | ns |
| | | V _{CC} = 3.0 V to 3.6 V | 1.5 | 3.0 | 5.3 | ns |
| t _{PHL} | HIGH to LOW propagation delay | nCP to nQn; see Fig. 5 | | | | |
| | | V _{CC} = 2.7 V | - | - | 5.1 | ns |
| | | V _{CC} = 3.0 V to 3.6 V | 1.5 | 3.0 | 4.9 | ns |
| t _{PZH} | OFF-state to HIGH propagation delay | nOE to nQn; see Fig. 7 | | | | |
| | | V _{CC} = 2.7 V | - | - | 6.9 | ns |
| | | V _{CC} = 3.0 V to 3.6 V | 1.5 | 3.5 | 5.6 | ns |
| t _{PZL} | OFF-state to LOW propagation delay | nOE to nQn; see Fig. 7 | | | | |
| | | V _{CC} = 2.7 V | - | - | 6.0 | ns |
| | | V _{CC} = 3.0 V to 3.6 V | 1.5 | 3.2 | 4.9 | ns |
| t _{PHZ} | HIGH to OFF-state propagation delay | nOE to nQn; see Fig. 7 | | | | |
| | | V _{CC} = 2.7 V | - | - | 5.7 | ns |
| | | V _{CC} = 3.0 V to 3.6 V | 1.5 | 3.5 | 5.4 | ns |
| t _{PLZ} | LOW to OFF-state propagation delay | nOE to nQn; see Fig. 7 | | | | |
| | | V _{CC} = 2.7 V | - | - | 5.1 | ns |
| | | V _{CC} = 3.0 V to 3.6 V | 1.5 | 3.2 | 5.0 | ns |
| t _{su} | set-up time | nDn to nCP; see Fig. 6 | | | | |
| | | V _{CC} = 2.7 V | 2.0 | - | - | ns |
| | | V _{CC} = 3.0 V to 3.6 V | 2.0 | 0.7 | - | ns |

3.3 V 16-bit edge-triggered D-type flip-flop with 30 Ω termination resistors; 3-state

| Symbol | Parameter | Conditions | Min | Typ[1] | Max | Unit |
|----------|------------------|---|-----|--------|-----|------|
| t_h | hold time | nDn to nCP; see Fig. 6 | | | | |
| | | $V_{CC} = 2.7\text{ V}$ | 0.1 | - | - | ns |
| | | $V_{CC} = 3.0\text{ V to }3.6\text{ V}$ | 0.8 | 0 | - | ns |
| t_{WH} | pulse width HIGH | nCP; see Fig. 5 | | | | |
| | | $V_{CC} = 2.7\text{ V}$ | 1.5 | - | - | ns |
| | | $V_{CC} = 3.0\text{ V to }3.6\text{ V}$ | 1.5 | 0.6 | - | ns |
| t_{WL} | pulse width LOW | nCP | | | | |
| | | $V_{CC} = 2.7\text{ V}$ | 3.0 | - | - | ns |
| | | $V_{CC} = 3.0\text{ V to }3.6\text{ V}$ | 3.0 | 1.6 | - | ns |

[1] Typical values are measured at $V_{CC} = 3.3\text{ V}$ and $T_{amb} = 25\text{ }^{\circ}\text{C}$.

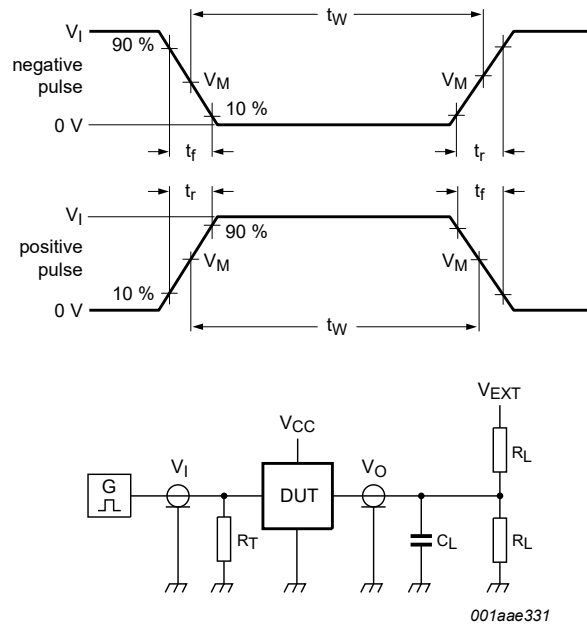
10.1. Waveforms and test circuit



3.3 V 16-bit edge-triggered D-type flip-flop with 30 Ω termination resistors; 3-state

Table 8. Measurement points

| Input | | Output | | |
|-------|-------|--------|-------------------------|-------------------------|
| V_I | V_M | V_M | V_X | V_Y |
| 2.7 V | 1.5 V | 1.5 V | $V_{OL} + 0.3\text{ V}$ | $V_{OH} - 0.3\text{ V}$ |



Test data is given in [Table 9](#).
Definitions:
 R_L = Load resistance;
 C_L = Load capacitance including jig and probe capacitance;
 R_T = Termination resistance should be equal to output impedance Z_o of the pulse generator;
 V_{EXT} = Test voltage for switching times.

Fig. 8. Test circuit for measuring switching times

Table 9. Test data

| Input | | | | Load | | V_{EXT} | | |
|-------|----------------------|--------|----------------------|-------|-------|--------------------|--------------------|--------------------|
| V_I | f_i | t_W | t_r, t_f | C_L | R_L | t_{PHZ}, t_{PZH} | t_{PLZ}, t_{PZL} | t_{PLH}, t_{PHL} |
| 2.7 V | $\leq 10\text{ MHz}$ | 500 ns | $\leq 2.5\text{ ns}$ | 50 pF | 500 Ω | GND | 6 V | open |

11. Package outline

TSSOP48: plastic thin shrink small outline package; 48 leads; body width 6.1 mm

SOT362-1

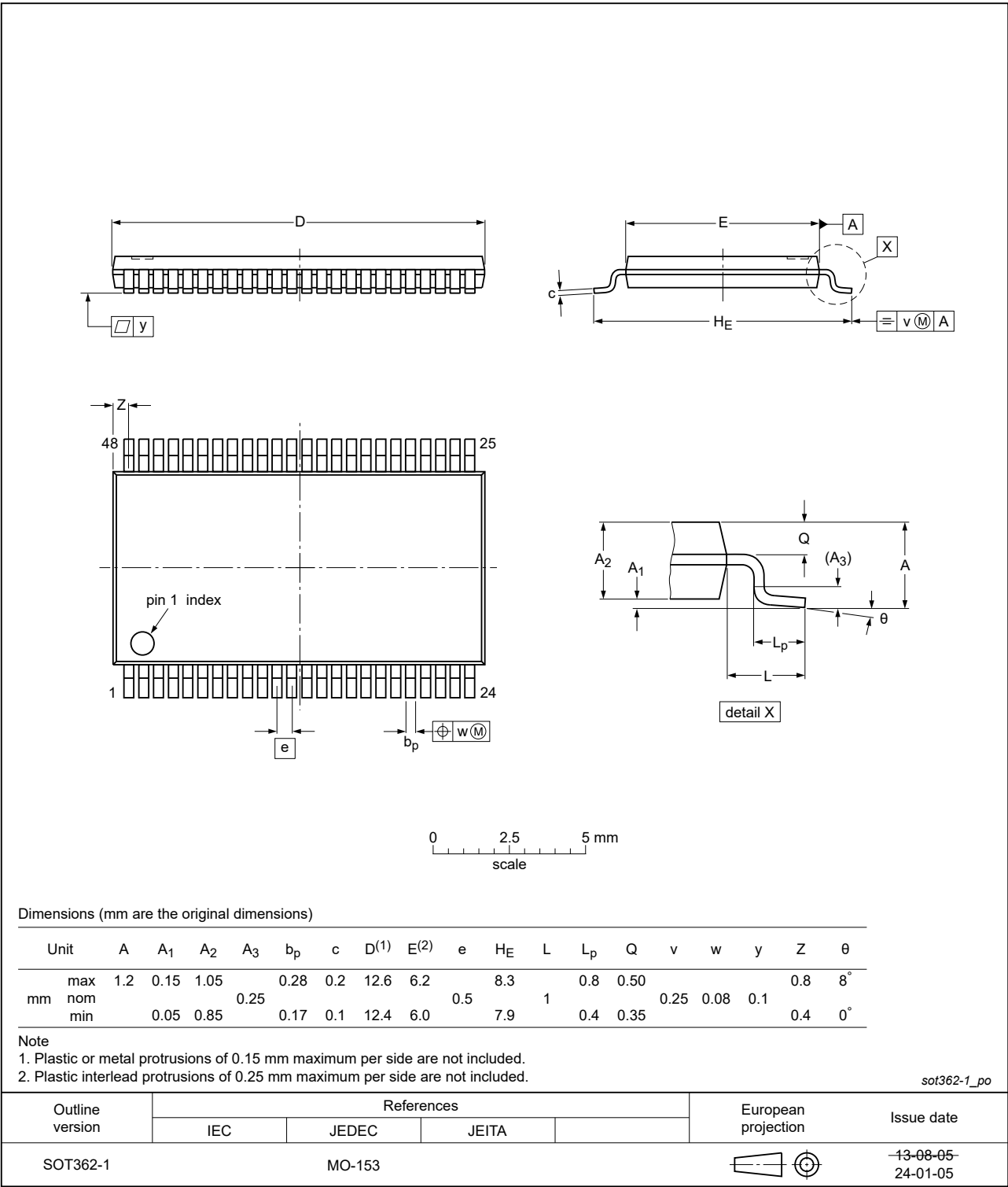


Fig. 9. Package outline SOT362-1 (TSSOP48)

12. Abbreviations

Table 10. Abbreviations

| Acronym | Description |
|---------|---|
| ANSI | American National Standards Institute |
| BiCMOS | Bipolar Complementary Metal Oxide Semiconductor |
| CDM | Charged Device Model |
| DUT | Device Under Test |
| ESD | ElectroStatic Discharge |
| ESDA | ElectroStatic Discharge Association |
| HBM | Human Body Model |
| JEDEC | Joint Electron Device Engineering Council |
| TTL | Transistor-Transistor Logic |

13. Revision history

Table 11. Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes |
|-----------------|---|-----------------------|---------------|-----------------|
| 74LVT162374 v.6 | 20240708 | Product data sheet | - | 74LVT162374 v.5 |
| Modifications: | <ul style="list-style-type: none">Section 2: ESD specification updated according to the latest JEDEC standard. | | | |
| 74LVT162374 v.5 | 20240201 | Product data sheet | - | 74LVT162374 v.4 |
| Modifications: | <ul style="list-style-type: none">Fig. 9: Updated package outline drawing SOT362-1 (TSSOP48). | | | |
| 74LVT162374 v.4 | 20181001 | Product data sheet | - | 74LVT162374 v.3 |
| Modifications: | <ul style="list-style-type: none">The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia.Legal texts have been adapted to the new company name where appropriate.Type number 74LVT162374DL (SOT370-1) removedSection "Quick reference data" removed | | | |
| 74LVT162374 v.3 | 20050117 | Product data sheet | - | 74LVT162374 v.2 |
| Modifications: | <ul style="list-style-type: none">The format of this data sheet is redesigned to comply with the current presentation and information standard of Philips Semiconductors.Section 2: Changed JEDEC Std 17 into JESD78Table 1 "Quick reference data": Changed t_{PLH} and t_{PHL} propagation delays nCP to nQn to 3.0 nsTable 7: Changed the minimum values of t_{h(H)} and t_{h(L)} hold time nDn to nCP to 0.8 ns | | | |
| 74LVT162374 v.2 | 20040922 | Product specification | - | 74LVT162374 v.1 |
| 74LVT162374 v.1 | 19990923 | Product specification | - | - |

14. Legal information

Data sheet status

| Document status [1][2] | Product status [3] | Definition |
|--------------------------------|--------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
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